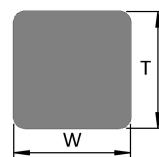
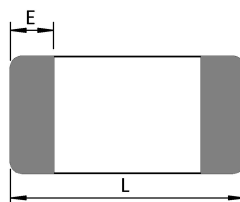
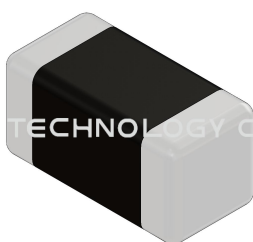


MCB1608H800HBP



Appearance & Shape

INPAQ TECHNOLOGY CO., LTD.



INPAQ TECHNOLOGY CO., LTD.



L	1.60±0.15
W	0.80±0.15
T	0.80±0.15
E	0.30±0.20

(unit:mm)



注意 NOTICE: All Specifications are subject to change without notice.

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2. 本文件僅說明參考標準規格，如需訂購，請依實際核准所需規格進行申辦。

Specification

L size(mm)	1.6±0.15
W size(mm)	0.8±0.15
T size(mm)	0.8±0.15
Size code Inch(mm)	0603(1608)
Impedance(Ω)	80
Tolerance(%)	±25
Test Frequency(MHz)	100
DCR(Ω) Max.	0.35
Irms(mA) @85°C (Max.)	500
Operating Temperature range(including self- temperature rising) °C	-55~+125

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Notices

- Monolithic inorganic material construction
- Closed magnetic circuit avoids crosstalk
- SMD Type & suitable for reflow and wave soldering
- Available in various sizes
- Excellent solderability and heat resistance
- High reliability
- With a sharp and frequency frequency impedance characteristics which can effectively filter high frequency noise without attenuating high frequency signal.

Packing

Packing Reel(Inch)	Packaging type	Standard package quantity(PCS)	Piece weight(gram)	MSL Level
7	Paper type	4000	0.005	1

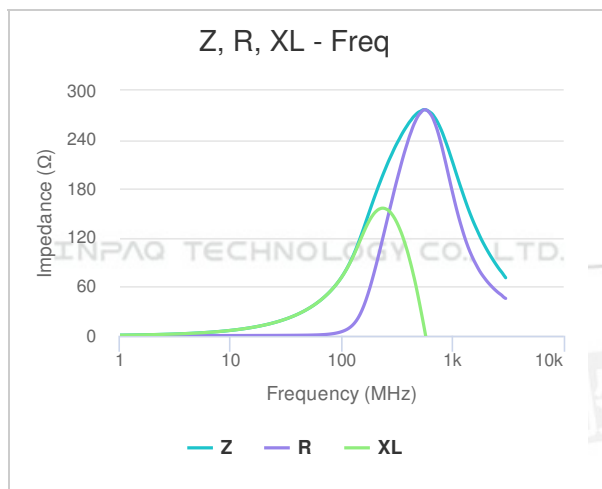
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Characteristic curve



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